

S/N: 09/832,884

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AF  
2829

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of: St ve M. Danziger, et al.

Serial No.: 09/832,884

Art Unit: 2829

Divisional of 09/321,565

Filed: April 12, 2001

Examiner: Evan T. Pert

For: Method and Apparatus for Evaluating a Known Good Die Using  
Both Wire Bond and Flip-Chip InterconnectsTRANSMITTAL

US Patent & Trademark Office  
2011 South Clark Place  
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JUN 15 2003  
TECHNOLOGY CENTER 2829

Sir: TRANSMITTED HERewith IS

☐ A RESPONSE, ☐ AN AMENDMENT, ☒ AN AMENDMENT AFTER FINAL,

IN THE ABOVE-IDENTIFIED APPLICATION.

☐ Small entity status of this application under 37 CFR §1.9(f) is established  
by a verified statement under 37 CFR §1.27 ☐ previously submitted.

☐ submitted herewith.


☒ No additional fee is required, as shown below.

CLAIMS PENDING AFTER AMENDMENT		CLAIMS PREVIOUSLY PAID		NEW CLAIMS EXTRA		ADDITIONAL FEES			
						SMALL ENTITY		OTHER THAN SMALL ENTITY	
TOTAL	8	MINUS	20	=	0	x\$9=	0.00	x\$18=	0.00
INDEP	1	MINUS	3	=	0	x\$42=	0.00	x\$84=	0.00
NEW MULTIPLE DEPENDENT CLAIMS					0	x\$140=	0.00	x\$280=	0.00
AND CLAIMS DEPENDENT THEREON					0	x\$140=	0.00	x\$280=	0.00
TOTAL ADDITIONAL FEE						0.00		0.00	

☒ X

This amount is believed to be correct, however, the Commissioner is hereby authorized to charge any deficiency or credit any overpayment to Deposit Account No. 19-2816. This authorization applies to both filing fees under 37 CFR §1.16 and processing fees (such as extension of time) under 37 CFR §1.17. A duplicate copy of this transmittal is attached.

Respectfully Submitted,



Ronald R. Snider

Registration No. 24,962

Date: June 2, 2003

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RRS/bam